



ZHEJIANG UNI-NE Technology CO., LTD

浙江宇力微新能源科技有限公司



U3500 Data Sheet

V 3.0

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120V Input, Switching Current Limit Step-Down Converter

General Description

The U3500 is a high-voltage, step-down, switching regulator that drives External power MOSFET with a current limit of 10A, typically. The wide 10V to 120V input range accommodates a variety of step-down applications, making it ideal for automotive, industry, and lighting applications. Hysteretic voltage-mode control is employed for very fast response. UNI's proprietary feedback control scheme minimizes the number of required external components.

The switching frequency is 70KHz, allowing for small component size. Thermal shutdown and short-circuit shutdown (SCS) provide reliable and fault-tolerant operations. Low quiescent current allows the U3500 to be used in battery-powered applications.

The U3500 is available in a ESOP-8 package with an exposed pad.

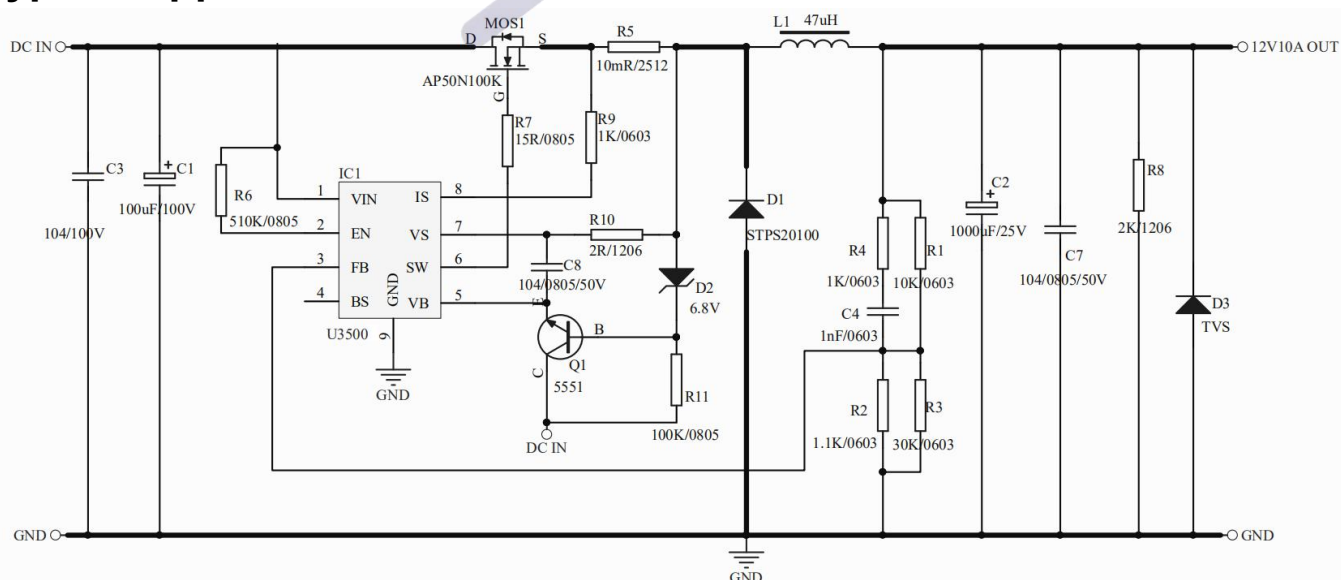
Key Features

- Wide 10V to 120V Input Range
 - DC-DC 12V/10A Typical Switching Current
- Application
- Hysteretic Control: No Compensation
 - 70KHz Switching Frequency
 - PWM Control Input for step-down
- Application
- Short-Circuit Shutdown (SCS) with Integrated IC
 - Low Quiescent Current
 - Thermal Shutdown
 - Available in a ESOP-8 Package with an Exposed Pad

Applications

- Scooters, E-Bike Control Power Supplies
- Solar Energy Systems
- Automotive System Power
- Industrial Power Supplies
- High-Power LED Drivers

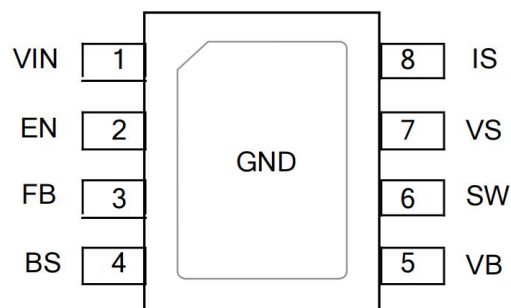
Typical Application



Ordering Information

Part Number	Package	Vo	VIN MAX	Load Current
U3500	ESOP-8	>2V	120V	Io<=10A

Pin Description



SOP-8 EP

Pin Functions

SOP-8 EP Pin #	Name	Description
1	VIN	Input supply. VIN supplies power to all of the internal control circuitries, both BST regulators, and the high-side switch. A decoupling capacitor to ground must be placed close to VIN to minimize switching spikes.
2	EN	Enable input. Pull EN below the specified threshold to shut down the U3500. Pull EN above the specified threshold or leave EN floating to enable the U3500.
3	FB	Feedback. FB is the input to the voltage hysteretic comparators. The average FB voltage is maintained at 200mV by loop regulation.
4	BS	Bootstrap. Connected to a bootstrap diode 1N4148.
5	VB	Boot. BST is the positive power supply for the internal, floating, high-side MOSFET driver. Connect a bypass capacitor between BST and SW.
6	SW	Switch node. SW is the output, drives External power MOSFET
7	VS	Switch source. Upper drive low potential
8	IS	Current detection. Current Sensing Input
9	EP-GND	Ground. GND should be placed as close to the output capacitor as possible to avoid the high-current switch paths. Connect the exposed pad to GND plane for optimal thermal performance.

Operation

Hysteresis Current Control with Adaptive Threshold Adjustment

The U3500 operates in a hysteretic voltage-control mode to regulate the output voltage. FB is connected to the tap of a resistor divider, which determines the output voltage. The power MOSFET is turned on when the FB voltage (V_{FB}) rises to FBon and remains on until V_{FB} rises to FBoff. The power MOSFET is turned off when V_{FB} drops to FBoff and remains off until V_{FB} falls to FBon. The two thresholds of FBon and FBoff are adjusted adaptively to compensate for all the circuit delays, so the output voltage is regulated with an average 1.25V value at FB.

Enable (EN) Control

The U3500 has a dedicated enable control pin (EN) with positive logic. Its falling threshold is 2.5V, and its rising threshold is 2.8V. When EN is pulled up to about 3V by an internal current source, so it is enabled.

Floating Driver and Bootstrap Charging

The floating power MOSFET driver is powered by an external bootstrap capacitor. This floating driver has its own under-voltage lockout (UVLO) protection. The UVLO rising threshold is 10V with a threshold error of 0.2V. The bootstrap capacitor is charged and regulated to about 5V by the dedicated internal bootstrap regulator.

If the internal circuit does not have sufficient voltage, and the bootstrap capacitor is not sufficiently charged, extra external circuitry can be used to ensure that the bootstrap voltage is in the normal operating region. Refer to the External Bootstrap Diode section for more details.

Under-Voltage Lockout (UVLO)

Under-voltage lockout (UVLO) is implemented to protect the chip from operating at an insufficient supply voltage. The UVLO rising threshold is about 10V, while its falling threshold is a consistent 9.5V.

Fast charging Function for USB Applications

Because the FB reference of the U3500 is very flexible, it is recommended to use the U3500 for USB Fast charging Applications by connecting the current sense resistor between FB and GND.

Thermal Shutdown

Thermal shutdown is implemented to prevent the chip from operating at exceedingly high temperatures. When the silicon die temperature is higher than its upper threshold, the entire chip shuts down. When the temperature is lower than its lower threshold, the chip is enabled again.

Output Short Shutdown Protection

The output voltage is well-regulated when V_{FB} is around 1.25V. If the output is pulled Shutdown in over-current protection (OCSP) or is shorted to GND directly, V_{FB} is low, Until the power MOSFET is turned on again. The U3500 regards the low V_{FB} as a failure. The power MOSFET is pulled Shutdown if the failure time is longer.

The power MOSFET current is also accurately sensed via a current sense MOSFET. If the current is over the current limit, the IC is pulled Shutdown. This offers extra protection under output- short conditions.

Application Information

Setting the Output Voltage

The output voltage (V_{OUT}) is set by a resistor divider ($R1$ and $R2$) (see the Typical Application on page 1). To achieve good noise immunity and low power loss, $R2$ is recommended to be in the range of $1k\Omega$ to $50k\Omega$. $R1$ can then be determined with Equation (1):

$$R1 = \frac{V_{OUT} - V_{FB}}{V_{FB}} \times R2 \quad (1)$$

Where V_{FB} is 1.25V, typically.

Output Capacitor and Frequency Setting

The output capacitor (C_{OUT}) is necessary for achieving a smooth output voltage. The ESR of the capacitor should be sufficiently large compared to the capacitance; otherwise, the system may behave in an unexpected way, and the current ripple may be very high. V_{FB} changes from 1.22V to 1.28V when the power MOSFET switches on. To charge the capacitor and generate 1.28V at FB, the system needs ESR and some inductor current. For example, for a 5V V_{OUT} , if the forward capacitor is 0.1 μ F, the suggested ESR range of the output capacitor is 100m Ω to 250m Ω . Tantalum or aluminum electrolytic capacitors with a small ceramic capacitor are recommended.

A forward capacitor across $R1$ is recommended when the output capacitor is tantalum or aluminum electrolytic, which can set the desired frequency if the output capacitor and ESR cannot be changed. The forward capacitor can reduce the output voltage ripple.

In some application, simply a forward capacitor may not get proper frequency, then we can add a forward resistor in series with the forward capacitor or even more add a ceramic on the output.

Selecting the Inductor

The inductor (L) is required to convert the switching voltage to a smooth current to the load. Although the output current is low, it is

recommended that the inductor current be continuous in each switching period to prevent reaching the current limit. Calculate the inductor value with Equation (2):

$$L = \frac{(V_{IN} - V_{OUT}) \times V_{OUT}}{F_{SW} \times I_{OUT} \times V_{IN} \times K} \quad (2)$$

Where K is a coefficient of about 0.15 ~ 0.85

Output Rectifier Diode

The output rectifier diode supplies current to the inductor when the high-side switch is off. To reduce losses due to the diode forward voltage and recovery times, use a Schottky diode. The average current through the diode can be approximated with Equation (3):

$$I_D = I_{OUT} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \quad (3)$$

Choose a diode with a maximum reverse voltage rating greater than the maximum input voltage and a current rating is greater than the average diode current.

Input Capacitor (C_{IN})

The input current to the step-down converter is discontinuous and therefore requires a capacitor to supply AC current to the step-down converter while maintaining the DC input voltage. Use low ESR capacitors for the best performance, especially under high switching frequency applications.

The RMS current through the input capacitor (4):

$$I_{IN_AC} = I_{OUT} \times \sqrt{\frac{V_{OUT}}{V_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)} \quad (4)$$

With low ESR capacitors, the input voltage ripple can be estimated with Equation (5):

$$\Delta V_{IN} = \frac{I_{OUT} \times V_{OUT}}{F_{SW} \times C_{IN} \times V_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \quad (5)$$

Choose an input capacitor with enough RMS current rating and enough capacitance for small input voltage ripples.

When electrolytic or tantalum capacitors are applied, a small, high-quality ceramic capacitor (i.e.: 0.1 μ F) should be placed as close to the IC as possible.

External Bootstrap Diode

An external bootstrap diode may enhance the efficiency of the converter (see Figure 2). An external VB diode is recommended from the BS supply to VB in the following cases:

- There is a 5V rail available in the system
- IO is greater than 1A

This diode is also recommended for high duty cycle operations (when $V_{OUT} / V_{IN} > 65\%$) and very high frequency applications.

The bootstrap diode can be a low-cost one, such as FR107.

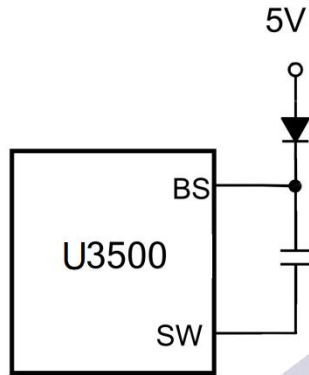


Figure 2: External Bootstrap Diode

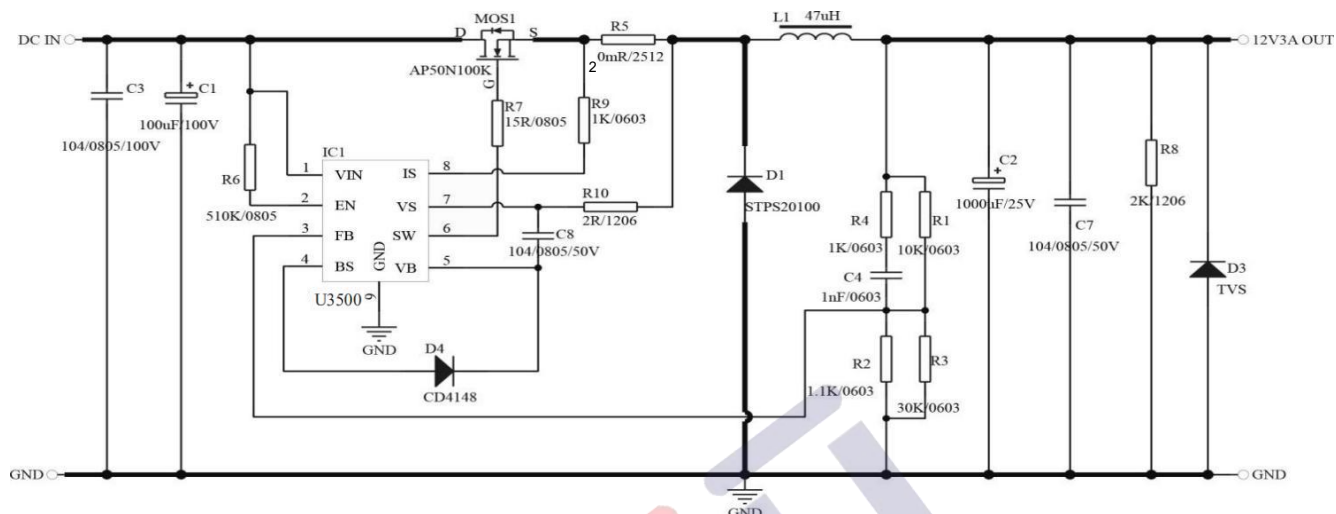
PCB Layout Guidelines

Efficient PCB layout is critical for stable operation. For best results, refer to Figure 3 and follow the guidelines below.

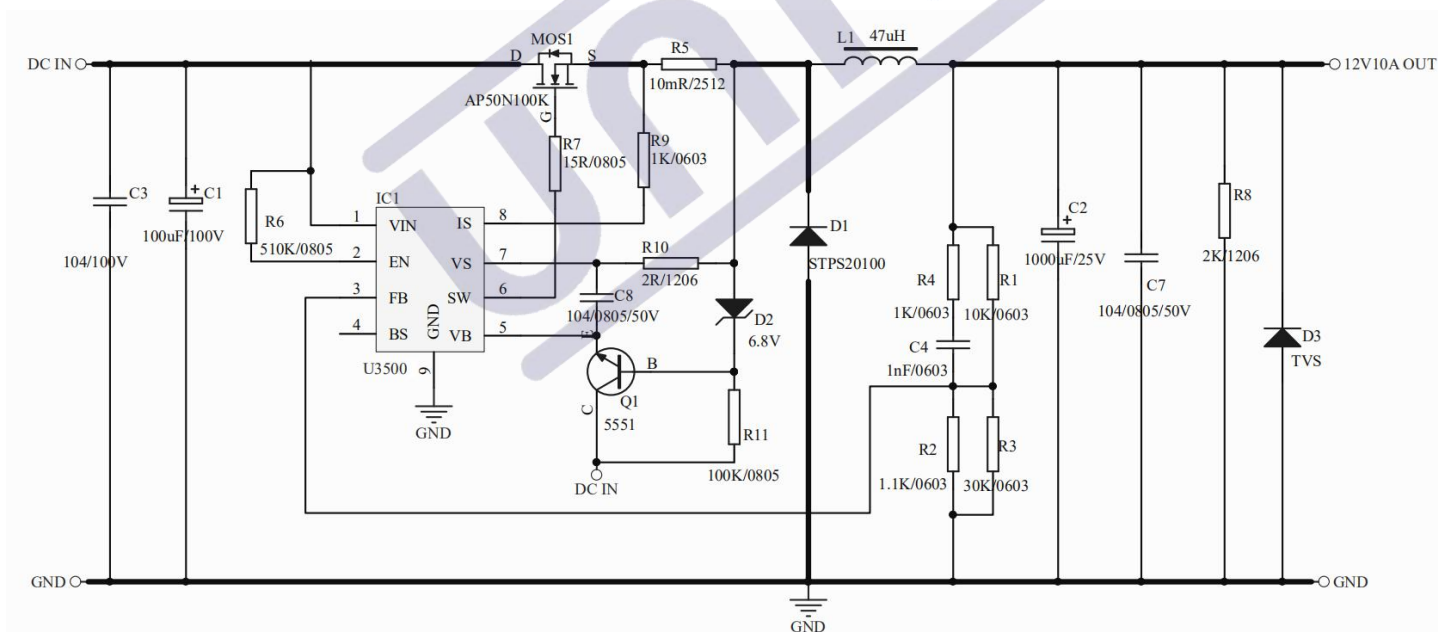
1. Place the input decoupling capacitor, catch diode, and the U3500 (VIN, SW, and PGND) as close to each other as possible.
2. Keep the power traces very short and fairly wide, especially for the SW node. This can help greatly reduce voltage spikes on the SW node and lower the EMI noise level.
3. Run the feedback trace as far from the inductor and noisy power traces (like the SW node) as possible.
4. Place thermal vias with 15mil barrel diameter and 40mil pitch (distance between the centers) under the exposed pad to improve thermal conduction.

Typical Application Circuit

APP1: $V_{OUT}=12.5V$, $I_{OUT}=3A$



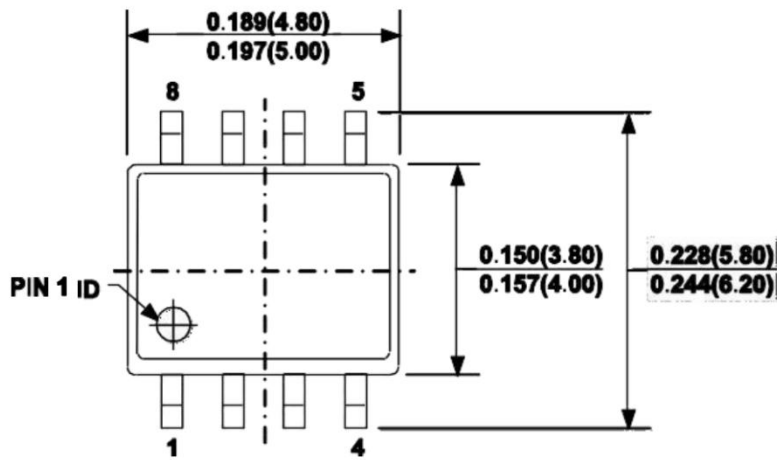
APP2: $V_{OUT}=12.5V$, $I_{OUT}=10A$



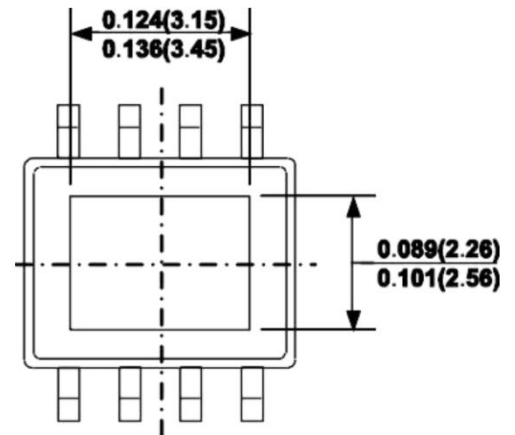
The circuit diagram illustrates a 12V 10A DC-DC converter. The input is a 104/100V DC source connected to the DC IN terminal. The circuit includes a pre-regulator stage with a diode D4 (ES1D) and a resistor R6. The main switching stage is controlled by the U3500 IC (IC1), which is configured with various resistors (R1, R2, R3, R4, R5, R7, R8, R9, R10, R11, R12) and capacitors (C1, C2, C3, C4, C5, C7, C8). The switching MOSFET (MOS1, AP50N100K) drives the inductor L1 (47uH). The output is a 12V 10A DC source connected to the 12V10A OUT terminal. The circuit also includes a diode D1 (STPS20100) and a diode D2 (6.8V) for protection and regulation. The ground connection is labeled GND.

Package Information

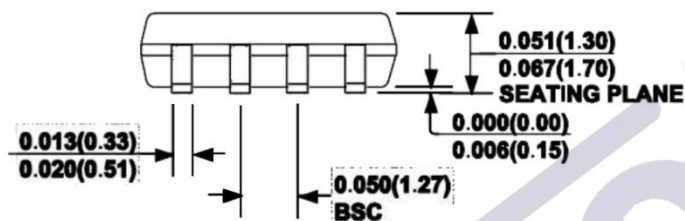
SOP-8 EP



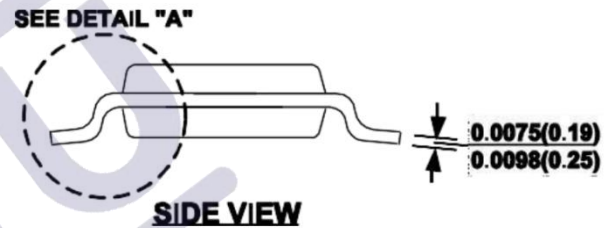
TOP VIEW



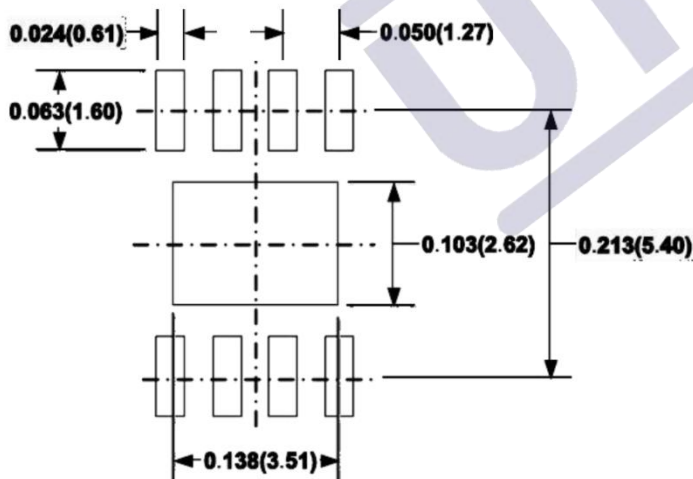
BOTTOM VIEW



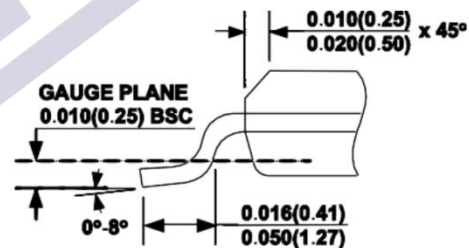
FRONT VIEW



SIDE VIEW



RECOMMENDED LAND PATTERN



DETAIL "A"

- NOTE:**
- 1) CONTROL DIMENSION IS IN INCHES
BRACKET IS IN MILLIMETERS.
 - 2) PACKAGE LENGTH DOES NOT INCLUDE MOLD FLASH,
PROTRUSIONS OR GATE BURRS.
 - 3) PACKAGE WIDTH DOES NOT INCLUDE INTERLEAD FLASH
OR PROTRUSIONS.
 - 4) LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING)
SHALL BE 0.004" INCHES MAX.
 - 5) DRAWING CONFORMS TO JEDEC MS-012, VARIATION BA.
 - 6) DRAWING IS NOT TO SCALE.

NOTICE:

The information in this document is subject to change without notice. Users should warrant and guarantee that third party Intellectual Property rights are not infringed upon when integrating UNI products into any application. UNI will not assume any legal responsibility for any said applications.

1.版本记录

DATE	REV.	DESCRIPTION
2018/04/ 19	1.0	First Release
2019/05/21	2.0	Package is changed SOP-8
2021/05/21	3.0	Package is changed to ESOP-8

2.免责声明

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3.联系我们

浙江宇力微新能源科技有限公司

总部地址：绍兴市越城区斗门街道袍渚路25号中节能科创园45幢4/5楼

电话：0575-85087896（研发部）

传真：0575-88125157

E-mail:htw@uni-semic.com

无锡地址：江苏省无锡市锡山区先锋中路6号中国电子（无锡）数字芯城1#综合楼503室

电话:0510-85297939

E-mail:zh@uni-semic.com

深圳地址：深圳市宝安区西乡街道南昌社区宝源路泳辉国际商务大厦410

电话：0755-84510976

E-mail:htw@uni-semic.com